TE Internal #: 2314979-1

CFP2, Cage Assembly, Sealable, Operating Temperature Range -55

-85 °C [-67 - 185 °F], 1 Ports, Port Matrix Configuration 1 x 1,

Included Lightpipe

View on TE.com >



#### Connectors > Pluggable IO Connectors & Cages











Form Factor: CFP2

Pluggable I/O Product Type: Cage Assembly

Sealable: Yes

Operating Temperature Range: -55 - 85 °C [ -67 - 185 °F ]

Number of Ports: 1

### **Features**

### Product Type Features

Cage Type	Single
Thermal Accessory Type Included	Heat Sink
Form Factor	CFP2
Pluggable I/O Product Type	Cage Assembly
Sealable	Yes

### **Configuration Features**

Number of Fins	17
Number of Ports	1
Port Matrix Configuration	1 x 1

#### **Body Features**

body realtires	
Heat Sink Style	Fin
Heat Sink Finish	Anodized Black
	.303 in
Primary Product Plating Material	Nickel



Primary Product Material	Aluminum Alloy
Termination Features	
Termination Method to PCB	Through Hole - Press-Fit
Mechanical Attachment	
PCB Mounting Style	Double-Sided (Belly-to-Belly)
Dimensions	
Product Width	45.2 mm
Product Length	78 mm
PCB Thickness (Recommended)	3 mm[.118 in]
Usage Conditions	
Usage Conditions  Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
	-55 – 85 °C[-67 – 185 °F]
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F] Yes
Operating Temperature Range  Operation/Application	
Operating Temperature Range  Operation/Application  Heat Sink Compatible	
Operating Temperature Range  Operation/Application  Heat Sink Compatible  Packaging Features	Yes
Operating Temperature Range  Operation/Application  Heat Sink Compatible  Packaging Features  Packaging Method	Yes

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU  EU ELV Directive 2000/53/EC  Compliant  Compliant
EU ELV Directive 2000/53/EC Compliant
China RoHS 2 Directive MIIT Order No 32, 2016  No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006  Current ECHA Candidate List: JAN 2025 (247)  Candidate List Declared Against: JUL 202 (219)  Does not contain REACH SVHC
Halogen Content  Not Low Halogen - contains Br or Cl > 90 ppm.
Solder Process Capability  Not applicable for solder process capabil

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**





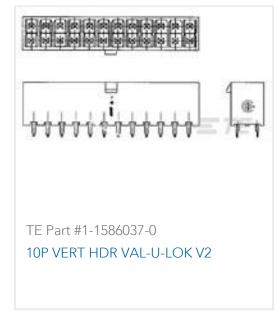


# **Customers Also Bought**

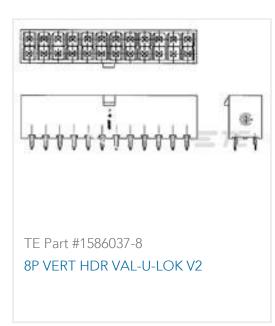






















### **Documents**

### **Product Drawings**

HARD WARE KITS WITH HS&LP,CFP2 1X1

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2314979-1\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2314979-1\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2314979-1\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

**Application Specification** 

English